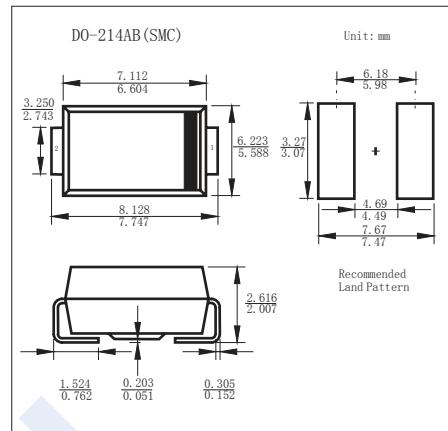


Schottky Diodes

SK32 ~ SK310

■ Features

- For Surface Mount Applications
- Extremely Low Thermal Resistance
- Easy Pick And Place
- High Temp Soldering: 250°C for 10 Seconds At Terminals
- High Current Capability With Low Forward Voltage



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	SK 32	SK 33	SK 34	SK 35	SK 36	SK 38	SK 310	Unit				
Repetitive Peak Reverse Voltage	V _{RRM}	20	30	40	50	60	80	100	V				
RMS Voltage	V _{RMS}	14	21	28	35	42	56	70					
Maximum DC Blocking Voltage	V _{DC}	20	30	40	50	60	80	100					
Forward Voltage @ I _{FM} =3A, T _J = 25°C	V _F	50			75		85						
Averaged Forward Current T _J =120°C	I _{FAV}	3							A				
Peak Forward Surge Current @ 8.3ms	I _{FSM}	100											
Maximum DC Reverse Current T _J =25°C T _J =100°C	I _R	5			20				mA				
Typical Junction Capacitance @1MHz,V _R =4V	C _j	250											
Thermal Resistance Junction to Lead	R _{θJL}	10							°C/W				
Junction Temperature	T _j	125							°C				
Storage Temperature	T _{stg}	-55 to 150											

■ Marking

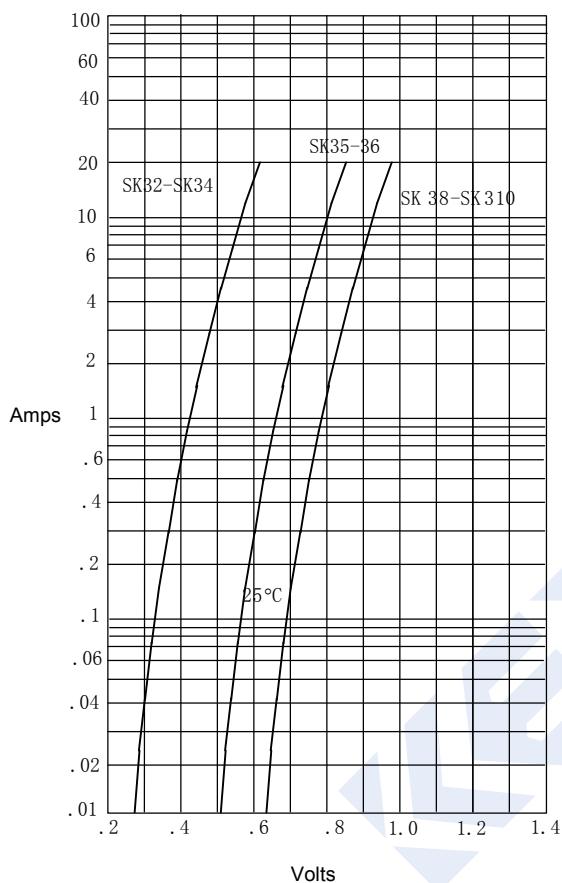
NO.	SK32	SK33	SK34	SK35	SK36	SK38	SK310
Marking	SK32	SK33	SK34	SK35	SK36	SK38	SK310

Schottky Diodes

SK32 ~ SK310

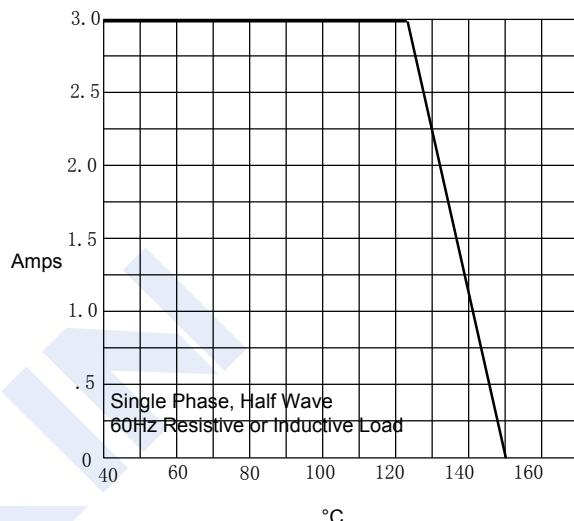
■ Typical Characteristics

Figure 1
Typical Forward Characteristics



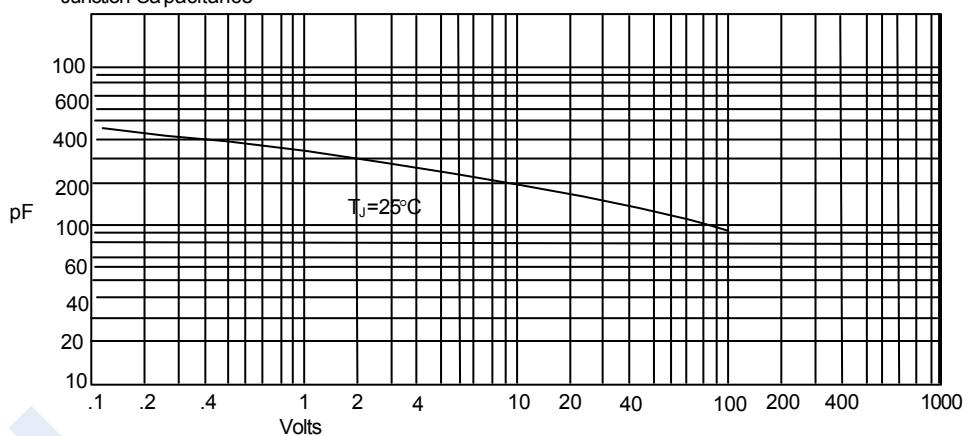
Instantaneous Forward Current - Amperes versus
Instantaneous Forward Voltage - Volts

Figure 2
Forward Derating Curve



Average Forward Rectified Current - Amperes versus
Ambient Temperature - °C

Figure 3
Junction Capacitance



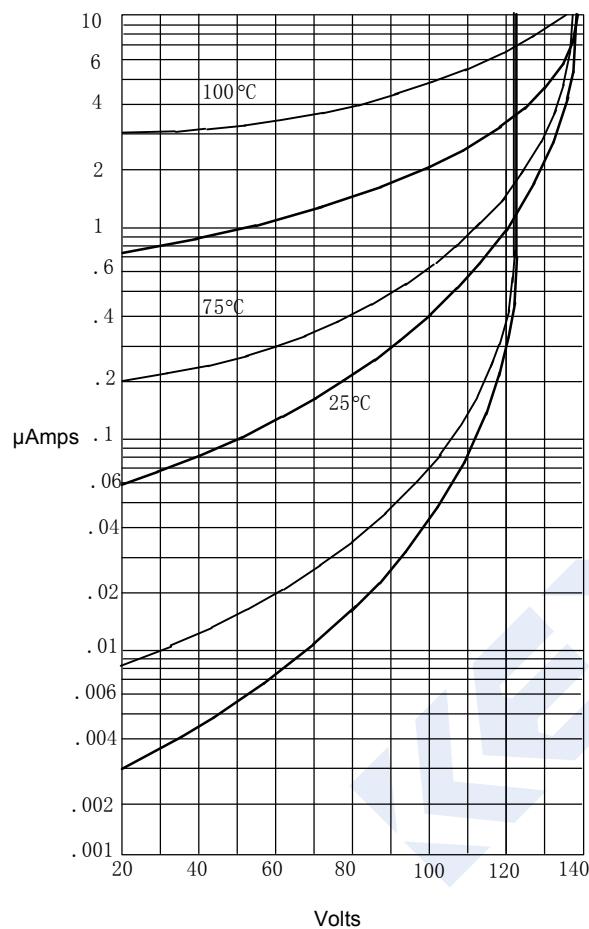
Junction Capacitance - pF versus
Reverse Voltage - Volts

Schottky Diodes

SK32 ~ SK310

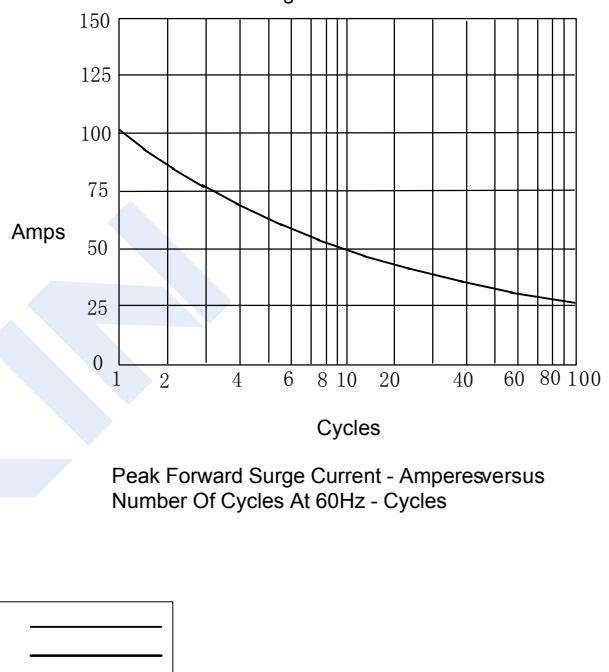
■ Typical Characteristics

Figure 4
Typical Reverse Characteristics



Instantaneous Reverse Leakage Current - MicroAmperesversus
Percent Of Rated Peak Reverse Voltage - Volts

Figure 5
Peak Forward Surge Current



Peak Forward Surge Current - Amperesversus
Number Of Cycles At 60Hz - Cycles

SK32-34 —————
SK35-310 —————